

Amendments to the Specification:

Please amend the specification by inserting the paragraph below, after the title on page 1.

Cross-Reference to Related Application

[0001.1] This application claims priority based on International Patent Application No. PCT/FR03/00954, entitled "Method for Handling Semiconductor Layers in Such a Way As to Thin Same" by Bernard Aspar, Marc Zussy and Jean-Frederic Clerc, which claims priority of French Application No. 02 03909, filed on March 28, 2002, and which was not published in English.